

## TELECOMMUNICATIONS TRANSMISSION TEST SET

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5                   **TELECOMMUNICATIONS TRANSMISSION TEST SET**

## BACKGROUND OF THE INVENTION

          This invention relates generally to test  
instrumentation, and in particular to a telecommunications  
10 transmission test set for testing digital communications  
networks.

          The advent of digital communications networks, such  
as the Internet, has generated great demands for high-speed  
data services. Conventional telephone modems can provide a  
15 limited data rate (i.e., up to 56 Kbps) before reaching the  
limit of performance for that technology. Other  
technologies, such as cable modem, can offer a leap forward  
in performance but are typically premised on changes in  
architecture that requires large investments in the  
20 communications network infrastructure.

          Digital subscriber line (DSL) is a technology that  
offers a solution to the demand for greater bandwidth. DSL  
offers data rates that can be substantially higher than that  
of a conventional telephone modem. Furthermore, DSL uses  
25 existing twisted copper pair lines that are deployed and  
prevalent throughout the world. DSL delivers a basic rate  
access of 128 Kbps (i.e., the ISDN rate). High speed digital  
subscriber line (HDSL), a variant of DSL, delivers a data  
rate of 1.544 Mbps (T1) in North America and 2.048 Mbps (E1)  
30 elsewhere. Asymmetric digital subscriber line (ADSL),  
another variant of DSL, delivers data rates of 1.5 to 9.0  
Mbps on the downstream path and 16 to 640 Kbps on the  
upstream path. More advanced variants of DSL promise even  
higher data rates. Collectively, DSL and variants of DSL are  
35 referred to as xDSL.

          xDSL technology typically consists of a pair of  
modems connected to two ends of one or more twisted wire  
pairs, depending on the xDSL variant. One modem resides at a  
central office and the other modem resides at the customer  
40 premises. The twisted wire pair(s) forms a local loop.

Generally, the maximum data rate is determined by the length of the local loop and the line conditions.

Installation, maintenance, and repair of an xDSL connection typically require execution of two sets of test:

- 5 (1) line qualification and (2) connectivity testing. Line qualification includes tests to determine the quality of a line transmission that, in turn, determines the maximum data rate that can be achieved by an xDSL modem. Conventionally, a transmission impairment measurement set (TIMS) is used to
- 10 qualify a line for xDSL service. The TIMS measures impairments such as frequency response, broadband noise, and signal power. One example of a TIMS is the OneTouch Network Assistance from Fluke Corporation that provides testing of patch cable and fiber optic cable. Unfortunately, the
- 15 OneTouch Network Assistance does not provide the traditional tests normally required for line qualification and connectivity testing.

Once a line has been qualified and an xDSL modem has been installed (i.e., at the central office),

20 connectivity testing is performed to verify data transmission over the modem. To perform connectivity testing, xDSL plug-in cards can be used. Generally, xDSL is provided by a number of manufacturers, many with proprietary designs. Thus, an xDSL plug-in card of a particular manufacturer is

25 installed in the test equipment and connectivity tests (e.g., bit-error-rate (BER) and loopback tests) are then performed. This scheme presents a challenge to service technicians and telecommunications operators who need to maintain an inventory of xDSL plug-in cards from various vendors. In

30 addition, the technicians need to correctly select the appropriate xDSL plug-in card for the particular local loop being tested.

A number of other challenges arise in testing digital communications networks. Conventionally, multiple

35 types of test equipment are required to perform the various tests necessary to qualify a line and to test connectivity. For example, one type of test equipment is used to qualify a line by performing various measurements (e.g., TDR, line impairment, and so on). Another type of test equipment is

5 test time are increased.

10 Hewlett-Packard Company. The CERJAC HDSL Installer's Assistance performs line coil detection and insertion loss measurements (to qualify a line) and BER and transmission loopback testing (for connectivity testing).

15 networks arises because the line qualification and connectivity testing are often performed in a mobile environment. The service technicians generally move from site to site to test the local loop. Furthermore, access to the local loop may be limited in certain instances.

20 Conventional test equipment are generally bulky and cumbersome, and not well suited for a mobile environment. For example, although touted as being portable, the CERJAC HDSL Installer's Assistance weighs a hefty 15 pounds.

25 the numerous amount of information that needs to be collected and presented for analysis. During the testing process, measurements are made and the test results are provided to a service technician who then configures the xDSL connection accordingly. In some conventional test sets, the test  
30 results are conveyed through simple LEDs on the front panel. However, LEDs can only display a limited amount of information. For some tests (i.e., power spectral density and load coil detection tests to qualify a line), large amounts of information are generated. Conventionally, the  
35 information is displayed or printed using alphanumeric characters. However, an alphanumeric display can be difficult to decipher and prone to mistake in interpretation.

From the above, a telecommunications transmission test set that is lightweight and portable, provides a

comprehensive suite of tests, and intelligently displays test results is needed in the art.

#### SUMMARY OF THE INVENTION

5           The present invention provides a telecommunications transmission test set for testing digital communications networks. In one embodiment, the test set is capable of performing line qualification testing including digital multimeter (DMM) tests, time domain reflection (TDR) test,  
10 and line impairment tests. The line impairment tests can include insertion loss, signal-to-noise, background noise, loop resistance, and other tests. In another embodiment, the test set is further capable of performing connectivity testing including loopback test and emulation. The test set  
15 can also be capable of performing bit-error-rate test (BERT). The test results can be graphically displayed on the test set.

          In one embodiment of the invention, the test set includes a modem module that facilitates connectivity  
20 testing. The modem module can be a plug-in module with a common interface. This allows one test set to be used with various modem modules. The modem module can also include a fingerprint value that identifies the modem module to the test set. The fingerprint value can indicate the module  
25 type, the software revision number, and so on. The test set then configures itself in accordance with the fingerprint value from the modem module.

          A specific embodiment of the invention provides a test set that includes at least one signal input port, test  
30 circuitry, a processor, a user input device, and a display. The test circuitry couples to and receives signals from the at least one signal input port. The test circuitry then generates test data corresponding to the received signals. The processor couples to and receives test data from the test  
35 circuitry and generates test results. The processor also couples to and receives commands from the user-input device. The processor further operatively couples to the display that receives and displays the test results from the processor. In one embodiment, the test set is capable of performing line

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qualification and connectivity testing. The display can be a graphical display to show the test results in graphical forms.

Another specific embodiment of the invention provides a test set for testing a communications network that includes a master tester unit and a modem module. The master tester unit receives a signal from the communications network and processes the signal to produce intermediate results. The modem module couples to the master tester unit, receives the intermediate results, processes the intermediate results, and provides processed results to the master tester unit. The master tester unit then displays the processed results. In a specific implementation, the modem module is a removable module (i.e., a plug-in module) that supports the test set in testing different communications networks (i.e., from different manufacturers). For example, a different modem module can be provided for each particular communications network to be tested. The test set is configurable to perform line qualification and connectivity testing.

The foregoing, together with other aspects of this invention, will become more apparent when referring to the following specification, claims, and accompanying drawings.

#### BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 shows a simplified block diagram of a digital communications network;

Fig. 2 shows an embodiment of a telecommunications transmission test set of the invention;

Fig. 3A shows a block diagram of an embodiment of the test set;

Figs. 3B-3D show block diagrams of an embodiment of a DMM test circuit, a TDR test circuit, and a line impairment test circuit, respectively;

Fig. 4A shows a block diagram of an embodiment of the modem module;

Fig. 4B shows a diagram of an embodiment for identifying a particular modem module to a test set;

Fig. 5 shows one embodiment of a menu tree;  
Fig. 6A shows a test set up for DMM measurements;  
Fig. 6B shows a graphical display of TDR test  
results, with "cursor" control;  
Fig. 6C shows a graphical display of TDR test  
results, with "marker" control;

Fig. 8A shows an embodiment of a menu for transmission line impairment testing;

Fig. 8C shows a graph of an insertion loss test result;

20            Fig. 8E shows an alphanumeric display of a signal-  
to-noise test result;

Fig. 9A shows a test set up for dual HTU-C and HTU-  
25 R emulation over two wire pairs;

Fig. 9C shows a complementary test set up to that of Fig. 9B;

Fig. 9E shows a test set up for E1 and T1 testing on a HDSL span;

Fig. 9G shows a test set up for testing ATU-C function; and

Fig. 9H shows a test set up for testing ATU-R function.

## DETAILED DESCRIPTION OF THE SPECIFIC EMBODIMENTS

Network Configuration

5           Fig. 1 shows a simplified block diagram of a  
specific embodiment of a digital communications network 100.  
Network 100 includes a central office 110 operatively coupled  
to a personal computer (PC) 120 through xDSL modems 130 and  
132. xDSL modem 130 couples to central office 110 and to a  
10 splitter 140a through a channel 142. xDSL modem 132 couples  
to PC 120 and to another splitter 140b through a channel 144.  
Splitters 140a and 140b are coupled through a local loop 150  
composed of one or more wire pairs, or other transmission  
media. Splitters 140a and 140b also couple to a public  
15 switched telephone network (PSTN) 152 and to a telephone 154,  
respectively, for providing a plain old telephone service  
(POTS). At the transmitting side, splitter 140 combines the  
POTS and data service into a signal suitable for transmission  
over local loop 150. At the receiving side, the other  
20 splitter 140 separates the received signal into the (lower  
frequency) voice telephone service and the (higher frequency)  
data service. In this manner, both voice and data can be  
transmitted over the same local loop concurrently without any  
modification to that loop.

25           The test set of the invention can be used to test a  
wide variety of communications networks, including network  
100. As used herein, "communications network" generically  
(and broadly) refers to any structure that supports a digital  
service carrier using any transmission technology. The  
30 transmission technologies covered by the test set of the  
invention includes plain old telephone system (POTS) modem,  
E1, T1, Integrated Services Digital Network (ISDN), Digital  
Subscriber Line (DSL), High data rate DSL (HDSL),  
Asynchronous DSL (ADSL), Very-high data rate DSL (VDSL), Rate  
35 Adaptive DSL (RADSL), Single line DSL (SDSL), and other  
variants of DSL. DSL and variants of DSL are collectively  
referred to as xDSL. The test set of the invention can also  
be adopted to cover transmission technologies such as hybrid  
fiber coax (HFC), coaxial cable, optical fiber, and others.

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## 5 Test Set

Implementation of some of the features of test set 200 is described in U.S. Patent No. 5,619,489, entitled "HAND-HELD TELECOMMUNICATION TESTER," issued April 8, 1997, assigned to the assignee of the present invention, and incorporated herein by reference.

Fig. 3A shows a block diagram of an embodiment of test set 200. Within test set 200, a processor 310 controls the operation of the test set according to program instructions stored in a memory 312. A digital signal processor (DSP) 314 can be used to assist in the processing of data samples (i.e., filtering, transformation, and so on). DSP 314 can be implemented, for example, with a digital signal processor from the TMS320 line of processors from Texas Instruments, Inc. An expansion card 316, which is an optional element, allows for easy upgrade to more advanced test features and more applications as they become available. Processor 310 couples to memory 312, DSP 314, and expansion card 316, and further to a bus 320 for communication with

Processor 310 can be implemented with a microcomputer, a microprocessor, a signal processor, an application specific integrated circuit (ASIC), or the like.

LED display 212, graphical display 214, and keypad 216 also couple to bus 320. LED display 212 and graphical display 214 receive commands from processor 310 and provide the appropriate output on their respective displays. Keyboard 216 provides the user input to processor 310.

A modem module interface 328 couples to bus 320 and a modem module 330 via a module bus 332. Modem module 330 facilitates connectivity testing and is further described below. Modem module interface 328 receives data and control signals from bus 320, formats the signals, and forwards the formatted signals to modem module 330. Modem module interface 328 also receives test data from modem module 330 and forwards the data to processor 310. Modem module interface 328 further acts as a conduit for the supply power to modem module 330.

Test set 200 also includes a power supply circuit 336 that provide power to the circuits within test set 200 and modem module 330. Power supply circuit 336 can receive

power from a battery pack 362 or an external power supply source. Power supply circuit 336 can be a switching power supply circuit, or other circuits. Power source 336 can also include a charger, such as a battery charger, for charging battery pack 338 with the external power supply source.

Fig. 3B shows a block diagram of an embodiment of DMM test circuit 322. In the embodiment shown in Fig. 3B, DMM test circuit 322 measures the line resistance, capacitance, DC voltage, and AC voltage. Initially, the line characteristics are converted into DC voltages by various conversion circuits. An analog-to-digital converter (ADC) 340 then samples the DC voltages on inputs 341 through 345 and provides the sampled values through bus 320 (i.e., to be received by processor 310 and/or DSP 314). The samples are then processed to determine the line characteristics.

For line resistance measurement, a voltage divider 346 converts the line resistance into a DC voltage that is then provided to ADC input 341. Voltage divider 346 couples to input 341, the line to be tested, and a test resistor 348 that further couples to a DC voltage source 350. In an embodiment, DC voltage source 350 provides eighty volts DC and test resistor 348 is forty Kohms. For DC line voltage measurement, the line to be tested is directly coupled to ADC input 342. For AC line voltage measurement, a root-mean-square (RMS) to DC voltage converter 352 converts the AC voltage on the line into a DC voltage at input 343 that is then sampled by ADC 340. And for line capacitance measurement, an AC voltage source 354 provides an AC voltage on the line under test. Two RMS to DC voltage converters 356 and 358 then convert the AC voltage on the line into DC voltages at inputs 344 and 345 that are then sampled by ADC 340. In an embodiment, AC voltage source 354 is a generator that provide a sinusoidal at 20 Hz and having 20 volts peak-to-peak amplitude.

Fig. 3C shows a block diagram of an embodiment of TDR test circuit 324. A pulse generator 360 generates a pulse when directed by processor 310. In an embodiment, pulse generator 360 has a variable time base and generates a single pulse when directed. A signal driver (AMP) 362, which

couple to generator 360, receives and conditions the pulse and drives the line to be tested. The reflected pulse is provided to a signal receiver 364 that conditions the received pulse. A programmable gain amplifier (PGA) 366, which couples to signal receiver 364, amplifies the conditioned pulse with a gain programmed by processor 310. A sample and hold analog-to-digital converter (ADC) 368, which couples to gain amplifier 366, samples the amplified pulse to generate sampled values. A latch 370, which couples to ADC 368, latches the sampled values and provides the latched values to bus 320. The pulse generated by generator 360 is also provided to a programmable delay element 372 that delays the pulse by a programmed amount of time and provides the delayed pulse to bus 320. As shown in Fig. 3C, generator 360, delay element 372, latch 370, ADC 368, and gain element 366 couple to bus 320 for receiving command from, and providing data to, other circuit elements that also couple to bus 320 (e.g., processor 310, DSP 314, and others).

Fig. 3D shows a block diagram of an embodiment of line impairment test circuit 326. A waveform synthesizer 380 generates a waveform (e.g., sinusoidal, squarewave, sawtooth, or others) as directed by processor 310. A lowpass filter 382, which couples to synthesizer 380, receives and filters the generated waveform. A signal driver 384, which couples to filter 382, receives and conditions the filtered signal and drives the line to be tested. The signal on the line is provided to a signal receiver (AMP) 386 that conditions the received signal. A lowpass filter 388, which couples to signal receiver 386, receives and filters the conditioned signal. An analog-to-digital converter (ADC) 390, which couples to filter 388, samples the filtered signal and provides the sampled values to bus 320. The sampled values are received and processed by, for example, processor 310 or DSP 314.

As shown in Fig. 2, test set 200 is designed to be a portable unit. In particular, test set 200 is dimensioned as a hand-held unit. In a specific embodiment, test set 200 is implemented to weigh less than three pounds, thus improving its portability feature.

### Modem Module

Fig. 4A shows a block diagram of an embodiment of modem module 330. Modem module 330 emulates an actual xDSL modem (e.g., an Alcatel modem, a Pair-Gain modem, or modems manufactured by other vendors) that will eventually be used (i.e., at the customer premises).

As shown in Fig. 4A, modem module 330 includes a processor 410 that controls the operation of modem module 330 according to program instructions stored in a memory 412. Processor 410 couples to modem module interface 328 of test set 200 via a data/address bus 420 and a serial bus 422. Through buses 420 and 422, processor 410 can send data to and receive instructions from test set 200. Processor 410 further couples to a modem circuit 430 and an optional test circuit 432. Processor 410 also optionally couples to a fingerprint circuit 434.

Processor 410 can be implemented with a microcomputer, a microprocessor, a signal processor, an ASIC, or the like. Memory 412 can be implemented as a RAM, a ROM, a PROM, an EPROM, a FLASH memory, registers, or other similar devices. Memory 412 can be used to store the program codes or data, or both.

Modem circuit 430 emulates the actual xDSL modem that will eventually be used for the communications network. Modem circuit 430 generally includes circuits that generate, format, send, receive, and process test data. Circuits that perform at least some of these functions are typically embodied in a chip set that can be obtained from the manufacturer of the actual xDSL modem. A processor within the chip set (not shown in Fig. 4A) typically controls the various functions. Modem circuit 430 can emulate a DSL, HDSL, ADSL, or other xDSL modems. Modem circuit 430 couples to a network interface 436 that provides an interface to the communications network under test. Network interface 436 can also provide circuit protection from transient signals on the network, and other functions.

As shown in Fig. 4A, test circuit 432 couples to processor 410 and modem circuit 430. Test circuit 432 can be

used to provide various functions such as, for example, to generate test patterns, to count errors, to generate signals to control the modem, and to facilitate ATM SAR testing.

Modem module 330 also includes a fingerprint  
5 circuit 434 that contains a "fingerprint" value. The fingerprint value is an identification value that identifies the a combination of: (1) the modem module type, (2) the software revision number, (3) the authorization codes, and so on, of the particular modem module 330. During an  
10 initialization stage, the fingerprint value is provided to test set 200. A table within test set 200 contains a comprehensive list of possible fingerprint values and their corresponding information. Test set 200 then determines the identity of modem module 330 by matching the fingerprint  
15 value from module 330 with that from the table.

Test set 200 can then configure itself in accordance with the fingerprint value from module 330. For example, the module type (e.g., Alcatel or PairGain) determines which connectivity test can be performed. The  
20 software revision number determines the available tests and test configuration. The authorization code can be used to determine which tests are permissible for that modem module 330. For example, test set 200 can be designed and manufactured with the capability to perform all tests.  
25 However, the authorization code of modem module 330 determines which ones of the tests are available (i.e., based upon payment of fees). Thereinafter, if the user selects a test not permitted for that modem module 330, test set 200 can display a screen such as "Test Not Available."

30 In one embodiment, modem module 330 is implemented as a plug-in card that couples to test set 200. The use of plug-in card is an improvement over conventional test sets that generally include built-in circuits (i.e., fixed cards) within the test set. With the use of a plug-in card, the  
35 same test set 200 can be used to test various xDSL modems by simply swapping plug-in cards.

Data/address bus 420 can be a universal data/address/control bus that is known in the art. Serial bus 422 can be a standard serial bus (i.e., an RS-232C bus

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having TTL logic levels). As shown in Figs. 3 and 4, power supply to modem module 330 is provided by test set 200. These various interface form a common interface scheme that allows test set 200 to be coupled to various modem modules.

5           The common interface scheme also allows test set 200 to control most of the functions of modem circuit 430. For modem circuits that include processors, communications between test set 200 and those modem circuits can be direct. However, for modem circuits that do not include processors, processor 410 provides the necessary interface between test  
10       set 200 and those modem circuits.

Fig. 4B shows a diagram of an embodiment for identifying a particular modem module to a test set. In Fig. 4B, a common software application 452 is installed onto test  
15       set 450. For the required testing (i.e., of a particular modem manufactured by a particular vendor), one of a set of modem modules 454 is coupled to (i.e., plugged in) a test set 450. Each of modem modules 454 includes an identification value (e.g., a fingerprint value) that identifies that modem  
20       module to test set 450. Test set 450 then executes the portion of the software application applicable for that particular modem module. For example, modem module 454b can be plugged in, and the identification value from modem module 454b directs test set 450 to execute the "B" portion of  
25       application 452 that is applicable to modem module 454b.

Fig. 4C shows a diagram of another embodiment for matching the proper software application with a particular modem module. As shown in Fig. 4C, a test set 460 can be loaded with one of a number of software applications 462a through 462n. Each software application 462 is designed for  
30       operation with a particular modem module 464. In this embodiment, when a particular modem module 464 is plugged in, the corresponding software application 462 is loaded onto test set 460 for execution. As shown in Fig. 4C, modem  
35       module 464a is plugged in test set 460 and corresponding software application 462a is installed.

Menu Screen

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Referring back to Fig. 2, a menu screen can be displayed on graphical display 214 upon power up of test set 200. The menu screen allows the user to: (1) change test parameters; (2) select the test to be performed; (3) store and recall test setup and/or results information; and so on. The user can navigate through the menu screen using keypad 216.

Fig. 5 shows one embodiment of a menu tree. A main menu 510 can be displayed upon power up of test set 200 or by depressing a proper key on keypad 216. As shown, main menu 510 includes the following choices: (1) xDSL, (2) DMM, (3) TDR, (4) Line, (6) Store/recall, and (6) other. Upon selecting the "xDSL" choice, a menu 512 is displayed. Menu 512 includes the following choices: (1) HDSL and (2) ADSL. Upon selecting the "HDSL" or "ADSL" choice, a menu 514 or 516 lists the available setup and test options.

Similarly, upon selecting the "DMM" choice in main menu 510, a menu 518 lists the available tests. Upon selecting the "Line" choice, a menu 520 lists the available tests. And upon selecting the "Other" choice, a menu 522 lists the available configuration and setup choices. For each of the menus described above, additional or different choices can be provided depending on the capability and design requirements of test set 200.

#### Test Capabilities

In one embodiment, test set 200 is capable of performing both line qualification and connectivity testing to allow complete installation, maintenance, and repairs of a xDSL connection. The test features are described below.

#### Line Qualification Tests

Line qualification includes a variety of tests that measure the quality or transmission capability of a wire pair. These tests can be grouped into three categories: (1) digital multimeter (DMM), (2) time domain reflection (TDR), and (3) transmission line impairments. DMM measurements can be used to detect shorts in the wire pair. TDR tests can be used to locate cable faults, such as the presence of loading



coils, bridge taps, water, and so on. Transmission line impairment tests can be used to characterize the transmission capabilities of the line and to determine if the wire pair is suitable for xDSL transmission within a predetermined  
5 frequency range (e.g., 10 KHz to 1.5 MHz).

#### Digital Multimeter (DMM) Tests

Fig. 6A shows a test set up for DMM measurements. Test set 200 couples to a wire pair 610 through a pair of  
10 clip cables 612. For a DMM measurement, a voltage is generated by test set 200 and provided across wire pair 610. Current is then detected from wire pair 610 to determine whether a short (i.e., low impedance or high impedance short) exists in wire pair 610. The various DMM functions are known  
15 in the art and are not discussed in detail in this specification.

In DMM mode, test set 200 can be used as a voltmeter or an ohmmeter. As a voltmeter (for both DC and AC voltage measurements), test set 200 can detect and measure  
20 (foreign) voltages on a wire pair. As an ohmmeter, test set 200 can be used to measure the resistance of a span of a wire pair. Generally, the resistance of a span is greater than five Mohm between a tip wire and ground and also between a ring wire and ground. Test set 200 can also measure the  
25 capacitance of a wire pair, which is helpful to determine the length of a line.

Test set 200 can also be used to measure loop resistance between a central office and the customer premises. The loop resistance is a DC measurement of the  
30 line. In one implementation of this test, two test sets are used, one located at the central office and the other at the customer premises. In an alternative implementation, one test set is used and the far end of the line is shorted. The loop resistance measurement can be used to verify that  
35 continuity exists between the central office and the customer premises and that no physical faults (e.g., grounds, shorts, or opens) exist in the loop.

For the various tests, the test result can be displayed on graphical display 214. Generally, an

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For TDR tests, the configuration as shown in Fig. 6A is used. Test set 200 sends out pulses of energy, one pulse at a time. When a reflection occurs, test set 200 measures the amplitude of the reflected pulse and the time interval between the transmission of the pulse to the reception of the reflected pulse. The measured time interval is used to determine the distance to the event. The amplitude of the reflected pulse is then plotted against distance. A bump (i.e., upward deflection from a baseline measurement) in the display indicates a high-impedance event. Alternatively, a dip (i.e., downward deflection from a baseline measurement) indicates a low-impedance event, such as a short. Based on the graphical display, a user can determine a fault and the distance to the fault.

Fig. 6B shows a graphical display of TDR test results, with "cursor" control. A result screen 630 can be reached from other menus of test set 200 by depressing the proper key on keypad 216. A vertical axis 632 represents the amplitude of the measured reflected pulse. A horizontal axis 634 represents distance. The vertical scale on axis 632 can be adjusted by depressing the Up and Down arrow keys on keypad 216. Similarly, the horizontal scale on axis 634 can be adjusted by depressing the F-keys on keypad 216. An

output graph 636 represents the measured results of the TDR measurement. Screen 630 also includes a cursor 638 that can be moved left or right by the Right and Left arrow keys on keypad 216.

5           An alphanumeric display section 640 lists pertinent data associated with the reflected pulse at the location of cursor 638. The data can include the amplitude of the reflected pulse, the distance to cursor 638, and so on. At the bottom of display section 640 are listed display options  
10 that can be selected using the Function keys. The options can include zoom in, zoom out, offset +, offset -, page left, page right, and so on.

          In one embodiment, as cursor 638 is moved to a pulse, vertical axis 632 is automatically adjusted (i.e., by  
15 adjusting the vertical gain, the vertical offset, or both) so that the pulse fits within screen 630. The pulse can also be moved to the center of screen 630 by depressing another key (not shown).

          Fig. 6C shows a graphical display of TDR test  
20 results, with "marker" control. A result screen 650 is similar to result screen 630, but includes a marker 652 that can be selected with, for example, the F1 key (see above discussion related to Fig. 6B). The marker can be moved left or right by depressing the left or right arrow key on keypad  
25 216. However, instead of listing the data at cursor 638 as with screen 630, display section 640 lists the difference between marker 652 and cursor 638.

          TDR can be used to locate various impairments in a wire pair that are detrimental for high-speed data  
30 transmission. The impairments include load coils, split pairs, bridge taps, laterals, water, intermittent faults, and so on. A load coil is an inductive component placed on a telephone line to improve the frequency response over the audio band (i.e., for voice communication). However, the  
35 load coil causes a sharp roll off at high frequency and needs to be removed for high-speed digital data transmission. A split pair is caused when two tips of the same color, but from different pairs, are inadvertently spliced together. A bridge tap (i.e., similar to a splice) is interposed on a

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wire pair to allow attachment an additional circuit to the wire pair. A lateral is a portion of a cable pair that is not in the direct path between the central office and the customer.

5 TDR tests are further described in a product application note entitled "Time Domain Reflectometry Theory" published by Hewlett-Packard Company in May 1998. Methods for determining fault locations are further described in a product application note entitled "Accurate Transmission Line  
10 Fault Location Using Synchronous Sampling" published by Hewlett-Packard Company in June 1998. Techniques for determining fault locations are also described in a product application note entitled "Traveling Wave Fault in Power Transmission Systems" published by Hewlett-Packard Company in  
15 February 1997. These application notes are incorporated herein by reference.

#### Transmission Line Impairment Tests

Fig. 7 shows a test set up for transmission line  
20 impairment testing. For this testing, two test sets 200a and 200b are used. Test sets 200a and 200b couple to wire pair 720 through respective pairs of clip cable 722 and 724. Test sets 200a and 200b are configured in a particular manner, depending on the test being conducted. Generally, master  
25 test set 200a conducts the measurements and slave test set 200b generates the required tones and properly terminates the far end of wire pair 720. Transmission impairment tests are further described in the publication ANSI T1.413, which is incorporated herein by reference.

30 Fig. 8A shows an embodiment of a menu 810 for transmission line impairment testing. Menu 810 can be reached from other menus of test set 200 by depressing the proper key on keyboard 216. Transmission impairment testing consists of the following measurements: (1) insertion loss,  
35 (2) signal-to-noise, (3) background noise, (4) loop resistance, and others. Also shown in menu 810 is a mode selection (i.e., master or slave) for the test unit.

#### Insertion Loss

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Insertion loss measures signal attenuation versus frequency across the wire pair. For insertion loss measurement, slave test set 200b sends a tone from the far end of the wire pair. Master test set 200a then measures the signal at the near end. Data is collected for a series of tone at various frequencies.

Fig. 8B shows a menu 820 that lists sets of test frequencies for insertion loss measurement. For ADSL discrete multi-tone (DMT) test, measurements are collected for 256 frequencies. Other test frequencies include: (1) 196 KHz for HDSL 2-pair T1, (2) 392 KHz for HDSL 1-pair T1, (3) 260 KHz for HDSL E1, (4) 40 KHz for ISDN U interface, (5) 96 KHz for ISDN S interface, (6) 82 KHz for DDS, (7) 772 KHz for T1, and (8) 1.024 MHz for E1. Alternatively, although not shown as a choice in Fig. 8B, the user can select a test frequency range and a frequency step size, thereby determining the frequencies to be tested.

Fig. 8C shows a graph of an insertion loss test result. A result screen 830 can be reached from other menus of test set 200 by depressing the proper key on keyboard 216. A vertical axis 832 represents the value of the insertion loss measurement. A horizontal axis 834 represents frequency or the tones of interest. An output graph 836 represents the measured result of the insertion loss measurement. A result can be plotted as each data point (or each frequency) is collected. A status message 838 indicates the status of the test. For example, "Testing" can be used to show that testing is in progress and "Complete" can be used to show that testing is finished. A cursor 840 can be placed anywhere on output graph 836. An alphanumeric display section 842 lists pertinent data associated with the test result at the location of cursor 840. Vertical axis 832, horizontal axis 834, and cursor 840 can be adjusted in similar manner to that described above for the TDR test.

Fig. 8D shows an alphanumeric display of insertion loss test results. A result screen 850 lists the frequencies and the corresponding measured values. Screen 850 can be used to display a more precise listing than output graph 836 shown in screen 830.

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## Signal-to-Noise Ratio

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in accordance with the following equation:

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T1.413 specification, equation 1 can be expressed as:

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## Background noise

Background noise measures the noise characteristics on the wire pair over a frequency band of interest.

Referring back to Fig. 7, for background noise measurement, slave test set 200b terminates the far end of wire pair 720

5 with the characteristic impedance of wire pair 720. Master test set 200a then performs measurement of the extraneous signals at the near end. A filter within test set 200a can be used for improved measurements. Example filters include:  
 10 (1) an E-filter having a (-3 dB) passband of 1 KHz to 50 KHz (for ISDN BRA DSL) and a characteristic impedance of 135 ohm,  
 (2) an F-filter having a passband of 5 KHz to 245 KHz (for HDSL) and a characteristic impedance of 135 ohm, (3) an G-filter having a passband of 20 KHz to 1.1 MHz (for ADSL) and a characteristic impedance of 100 ohm, and other filters.

15 Fig. 8F shows a graphical display of background noise test results. A result screen 870 includes a vertical axis 872, a horizontal axis 874, an output graph 876, and a cursor 878. Screen 870 can also include a status message 880 indicating the status of the test. A result can be plotted  
 20 as each data point (i.e., for a frequency) is collected. Cursor 878 can be placed anywhere on output graph 876. An alphanumeric display section 882 lists pertinent data associated with the test result at the location of cursor 878. Vertical axis 872, horizontal axis 874, and cursor 878  
 25 and be adjusted in similar manner to that described above. The results shown in screen 870 can also be displayed on an alphanumeric table, as described above. Furthermore, the background noise of the filters used in the testing can also be measured and displayed.

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#### Loop resistance

Loop resistance measures the impedance of a wire pair. Referring back to Fig. 7, for loop resistance measurement, slave test set 200b short circuits the far end  
 35 of the wire pair. Master test set 200a then performs measurements at the near end. The test result is then displayed.

#### Connectivity Testing

15           The use of the plug-in card (or a "universal" plug-in) provides many advantages. Generally, the modem interface is unique from one modem vendor to another. For example, Alcatel SA, Motorola Inc., Pairgain Technologies Inc., NEC Corporation, and Lucent Technologies Inc. are among the  
20 vendors that use different modem chip sets having different interfaces. The plug-in card of the invention can be designed to interface with these various modems, thereby allowing testing of multiple (seemingly incompatible) modems with one test set.

25           A network can be viewed as being composed of various layers, with each layer performing a defined function. Each layer communicates with the layer above or below it, or both. An Open System Interconnection (OSI) network is composed of seven layers including: (1) a physical  
30 layer, (2) a data link layer, (3) a network layer, (4) a transport layer, (5) a session layer, (6) a presentation layer, and (7) an application layer. The physical layer transmits bit streams across the physical transmission system. The data link layer provides for a reliable data  
35 transmission. The network layer routes data from one network node to another. The transport layer provides data transfer between two users at a predetermined level of quality. The session layer manages the data exchange. The presentation layer presents information to the users in a meaningful



manner. Finally, the application layer monitors and manages the computer network. The layers are further described by G. Nunemacher in "LAN Primer", M & T Books, pg. 179-181, which is incorporated herein by reference.

5           Layer 1 testing by test set 200 includes BERT, loopback control test, and other tests. BERT includes tests using any permutation of the following parameters: (1) T1 or E1, (2) in HTU-C mode, in HTU-R mode, from T1 access point, or from E1 access point. Loopback control test includes HTU-  
10 C, HTU-R, and CSU/NIU tests.

          Layer 2 testing by test set 200 includes emulation, loopback, and other tests. For HDSL, HTU-R emulation, HTU-C emulation, HTU-R loopback, and HTU-C loopback can be performed. HTU-R loopback is a regenerative loop back of the  
15 DSX-1 signal toward the network and HTU-C loopback is a regenerative loop back of the DS1 signal toward the network.

          Layer 3 testing by test set 200 includes IP ping test and other tests. As an analogy, testing layer 2 and 3 is akin to testing a microphone by saying "hello." For this  
20 test, a source unit sends a message to a far end unit that replies with a message back to the source unit.

          The test set of the invention can be designed to test various protocols including ISDN, Asynchronous Transfer Mode (ATM), Frame Relay, and others. ATM interoperability  
25 testing is further described in a product literature entitled "Testing ATM Interoperability," published by Hewlett-Packard Company in June 1997, and incorporated herein by reference.

#### Emulation

30           Fig. 9A shows a test set up for dual HTU-C and HTU-R emulation over two wire pairs. Test set 200a couples to one end of wire pairs 910a and 910b. Test set 200b couples to the other end of wire pairs 910a and 910b. The emulation test is used to verify that the wire pairs can support HDSL  
35 with an acceptable error rate.

          Fig. 9B shows a test set up for in-service HTU-C or HTU-R function. Test set 200a couples to a T1/E1 connection 920 and to one end of wire pairs 922a and 922b. The other end of wire pairs 922a and 922b couples to an HTU-R

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924 that further couples to a NIU 926 through a T1/E1 connection 928.

Fig. 9C shows a complementary test set up to that of Fig. 9B. HTU-C couples to a T1/E1 connection 932 and to one end of wire pairs 934a and 934b. The other end of wire pairs 934 couples to test set 200b that further couples to a T1/E1 connection 936.

In the in-service HTU-C or HTU-R function mode, test set 200 can perform the following tests: (1) in-service BERT (east or west), (2) respond to loopback commands, (3) report modem status, (4) in-service HTU monitoring measurements, and others. In this mode, the test set simulates a line terminating unit (LTU) or a networking terminating unit (NTU).

Fig. 9D shows a test set up for out-of-service HTU-C and HTU-R function. Test set 200 couples to one end of wire pairs 942a and 942b. The other end of wire pairs 942a and 942b couples to an HTU-R or an HTU-C 944 that further couples to a NIU/CSU 946. NIU/CSU 946 is configured as a loopback.

In the out-of-service HTU-C and HTU-R function mode, test set 200 can perform the following tests: (1) BERT at T1, (2) HTU/T1 loopback, (3) modem status, and others. These tests implement the HDSL loopback test.

Fig. 9E shows a test set up for E1 and T1 testing on a HDSL span. Test set 200 couples a HTU-C 950 through a T1/E1 connection 952. HTU-C 950 couples to HTU-R 954 through wire pairs 956a and 956b. HTU-R 954 couples to a CSU/NIU 958 through another T1/E1 connection 960. CSU/NIU 958 is configured as a loopback.

In the E1 and T1 testing mode, test set 200 can perform the following tests: (1) E1/T1 end-to-end BERT, (2) E1/T1/HTU loopback control, and others. These tests implement the TI loopback test.

Fig. 9F shows a test set up for simultaneous ATU-C and ATU-R emulation. Test set 200a couples a splitter 970a through a connection 972. Splitter 970a couples to another splitter 970b though a wire pair 974. Wire pair 974 is the

924 that further couples to a NIU 926 through a T1/E1 connection 928.

